

HIGH ISOLATION VOLTAGE  
SOP PHOTOCOUPLER

–NEPOC™ Series–

## DESCRIPTION

The PS2801-1 and PS2801-4 are optically coupled isolators containing a GaAs light emitting diode and an NPN silicon phototransistor in a plastic SOP for high density applications.

This package has shield effect to cut off ambient light.

## FEATURES

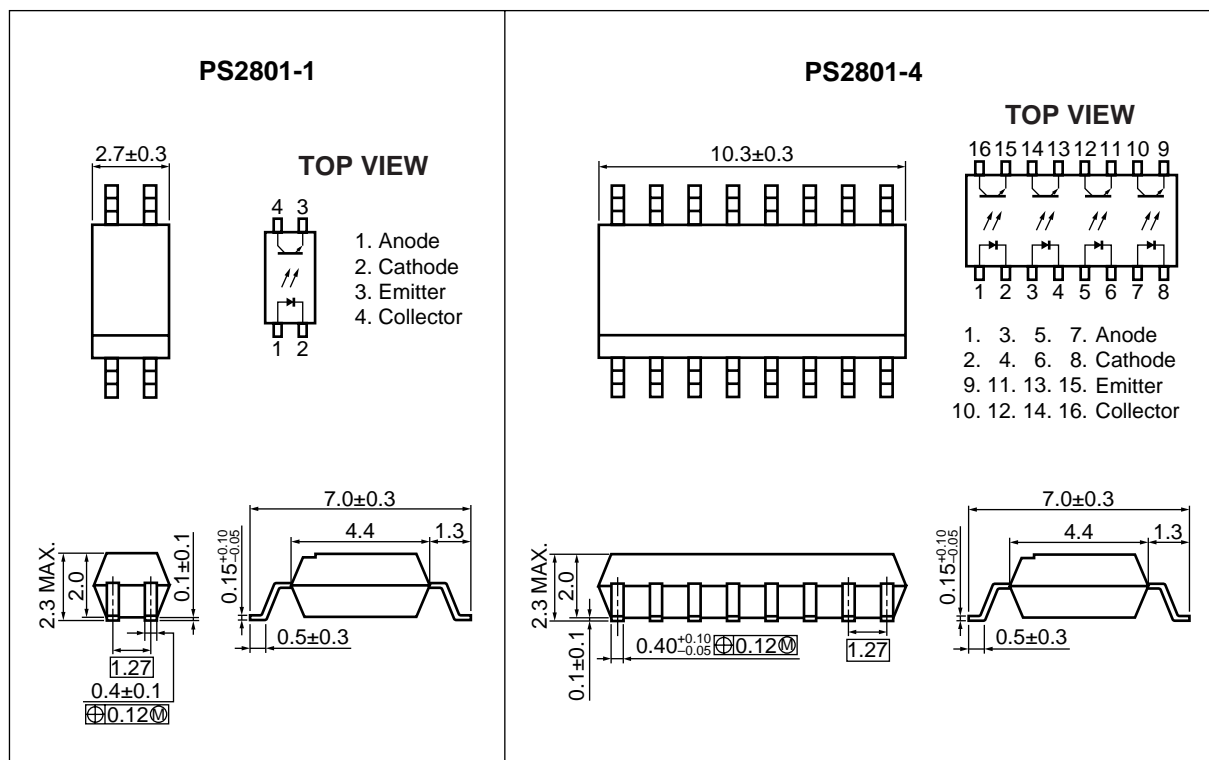
- High isolation voltage ( $BV = 2\,500\text{ V r.m.s.}$ )
- Small and thin package (4,16-pin SOP, Pin pitch 1.27 mm)
- High collector to emitter voltage ( $V_{CEO} = 80\text{ V}$ )
- High-speed switching ( $t_r = 3\text{ }\mu\text{s TYP.}$ ,  $t_f = 5\text{ }\mu\text{s TYP.}$ )
- Ordering number of tape product: PS2801-1-F3, F4, PS2801-4-F3, F4
- ★ • Safety standards: PS2801-1, -4
  - UL approved: File No. E72422 (S)
  - BSI approved: No. 8188, 8189
  - VDE0884 approved (Option): PS2801-4 only

## APPLICATIONS

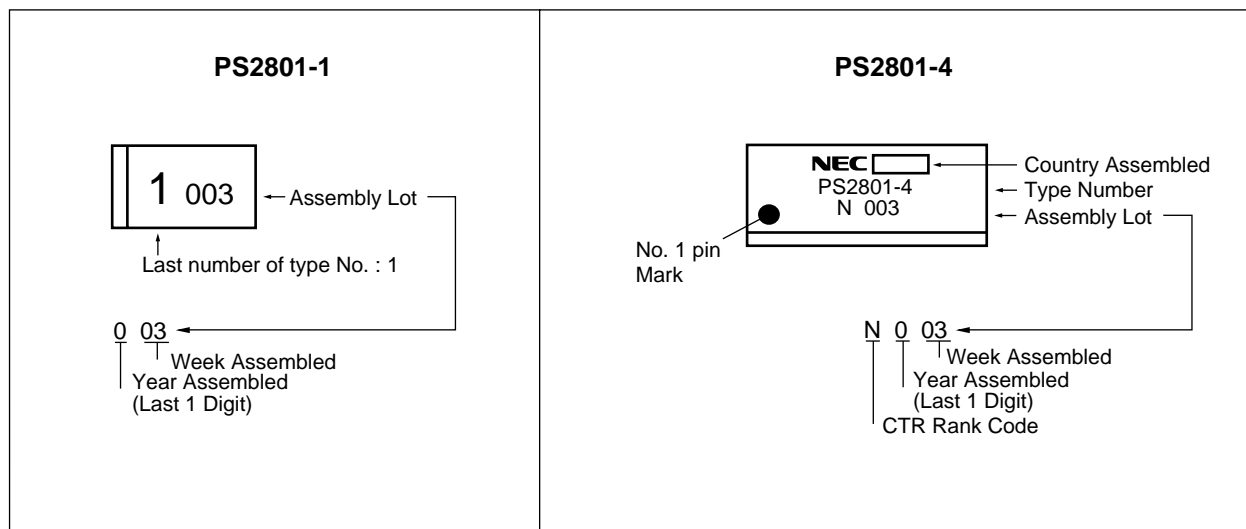
- Programmable logic controllers
- Measuring instruments
- Power supply
- Hybrid IC

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

PACKAGE DIMENSIONS (UNIT: mm)



★ MARKING



★ ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number <sup>*1</sup>
PS2801-1	4-pin SOP	50 pcs (Tape 50 pcs cut)	PS2801-1
PS2801-1-F3		Embossed Tape 3 500 pcs/reel	
PS2801-1-F4			
PS2801-4	16-pin SOP	Magazine Case 45 pcs	PS2801-4
PS2801-4-F3		Embossed Tape 2 500 pcs/reel	
PS2801-4-F4			

\*1 For the application of the Safety Standard, following part number should be used.

**ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C, unless otherwise specified)**

Parameter		Symbol	Ratings		Unit
			PS2801-1	PS2801-4	
Diode	Forward Current (DC)	I <sub>F</sub>	50		mA
	Reverse Voltage	V <sub>R</sub>	6		V
	Power Dissipation Derating	ΔP <sub>D</sub> /°C	0.6	0.8	mW/°C
	Power Dissipation	P <sub>D</sub>	60	80	mW/ch
	Peak Forward Current <sup>*1</sup>	I <sub>FP</sub>	1		A
Transistor	Collector to Emitter Voltage	V <sub>CEO</sub>	80		V
	Emitter to Collector Voltage	V <sub>ECO</sub>	6		V
	Collector Current	I <sub>C</sub>	50		mA/ch
	Power Dissipation Derating	ΔP <sub>C</sub> /°C	1.2		mW/°C
	Power Dissipation	P <sub>C</sub>	120		mW/ch
Isolation Voltage <sup>*2</sup>		BV	2 500		Vr.m.s.
Operating Ambient Temperature		T <sub>A</sub>	-55 to +100		°C
Storage Temperature		T <sub>stg</sub>	-55 to +150		°C

\*1 PW = 100 μs, Duty Cycle = 1 %

\*2 AC voltage for 1 minute at T<sub>A</sub> = 25 °C, RH = 60 % between input and output

ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
★ Diode	Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 5 mA		1.1	1.4	V
	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V			5	μA
	Terminal Capacitance	C <sub>t</sub>	V = 0 V, f = 1.0 MHz		15		pF
Transistor	Collector to Emitter Dark Current	I <sub>CEO</sub>	V <sub>CE</sub> = 80 V, I <sub>F</sub> = 0 mA			100	nA
Coupled	Current Transfer Ratio (I <sub>c</sub> /I <sub>F</sub> ) <sup>*1</sup>	CTR	I <sub>F</sub> = 5 mA, V <sub>CE</sub> = 5 V	80		600	%
	Collector Saturation Voltage	V <sub>CE(sat)</sub>	I <sub>F</sub> = 10 mA, I <sub>c</sub> = 2 mA			0.3	V
	Isolation Resistance	R <sub>I-O</sub>	V <sub>I-O</sub> = 1.0 kV <sub>DC</sub>	10 <sup>11</sup>			Ω
	Isolation Capacitance	C <sub>I-O</sub>	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time <sup>*2</sup>	t <sub>r</sub>	V <sub>CC</sub> = 5 V, I <sub>c</sub> = 2 mA, R <sub>L</sub> = 100 Ω		3		μs
	Fall Time <sup>*2</sup>	t <sub>f</sub>			5		

★ \*1 CTR rank (PS2801-1 only)

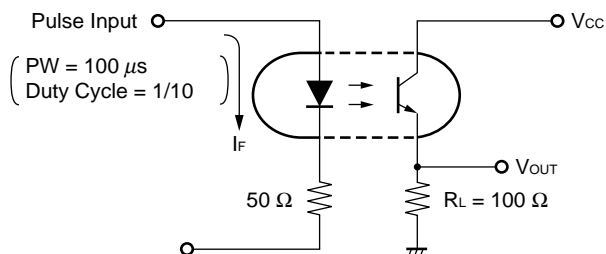
K : 300 to 600 (%)

P : 150 to 300 (%)

L : 100 to 300 (%)

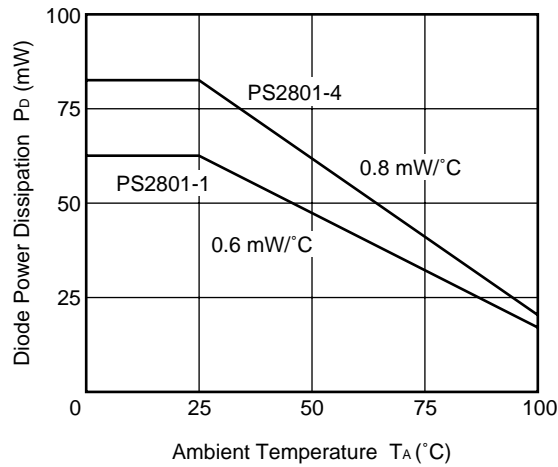
N : 80 to 600 (%)

\*2 Test circuit for switching time

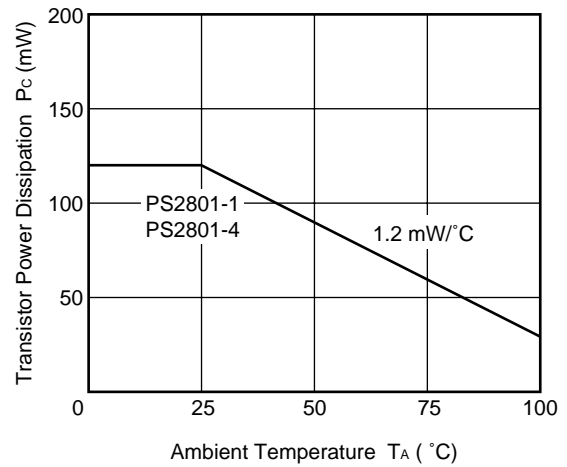


**TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , unless otherwise specified)**

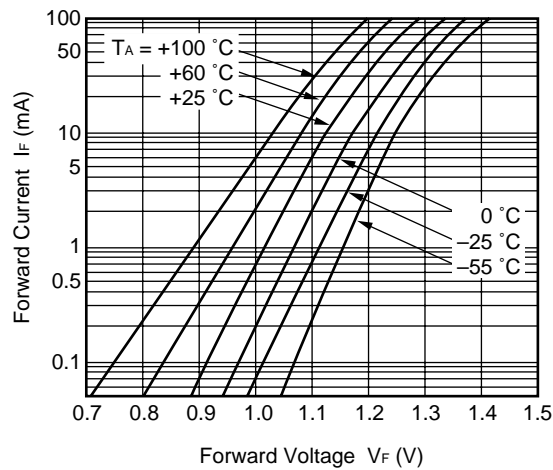
**DIODE POWER DISSIPATION vs. AMBIENT TEMPERATURE**



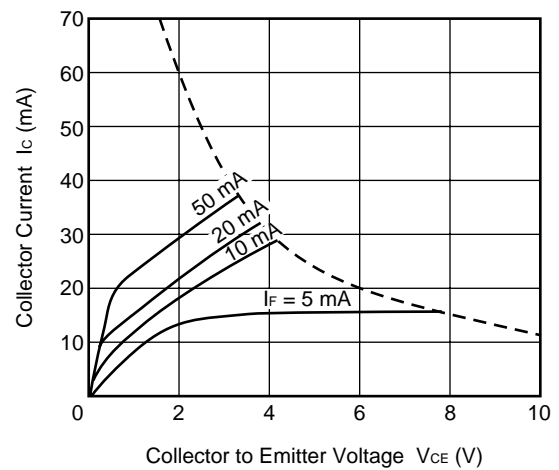
**TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE**



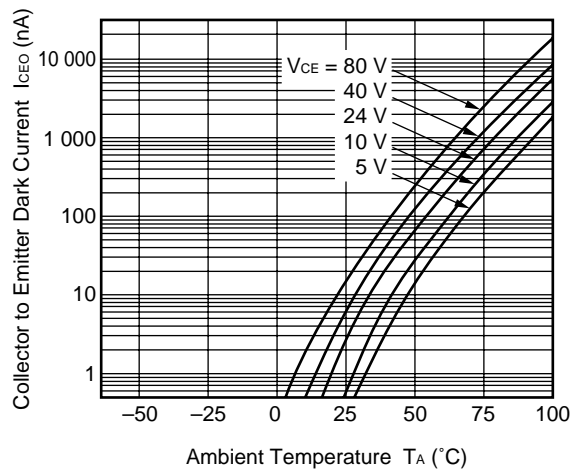
**FORWARD CURRENT vs. FORWARD VOLTAGE**



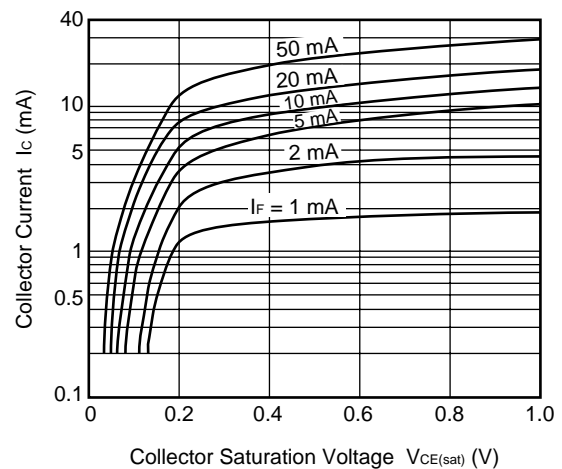
**COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE**



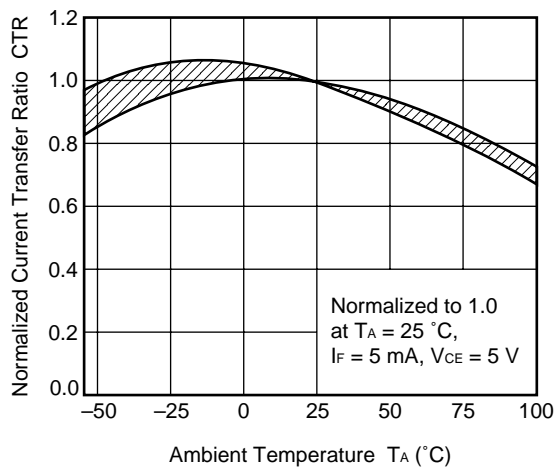
**COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE**



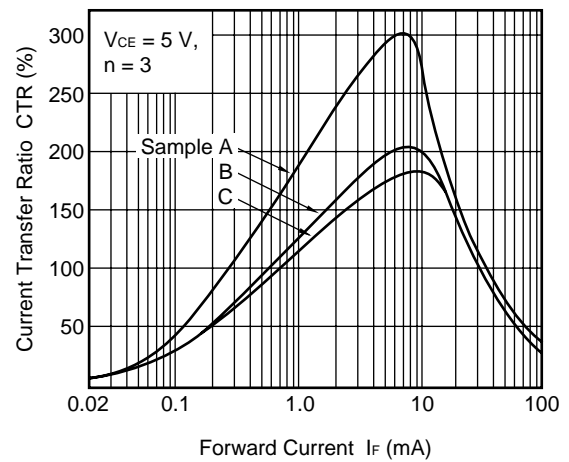
**COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE**



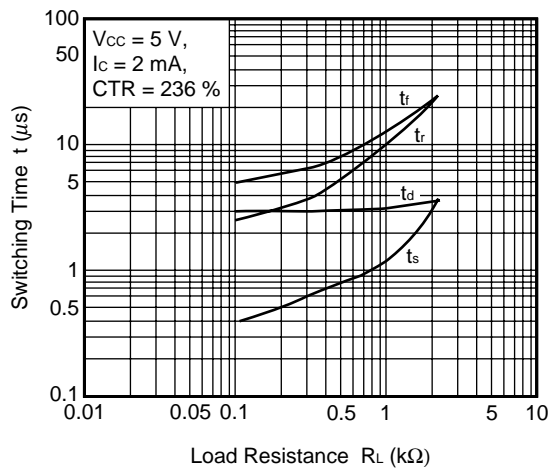
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



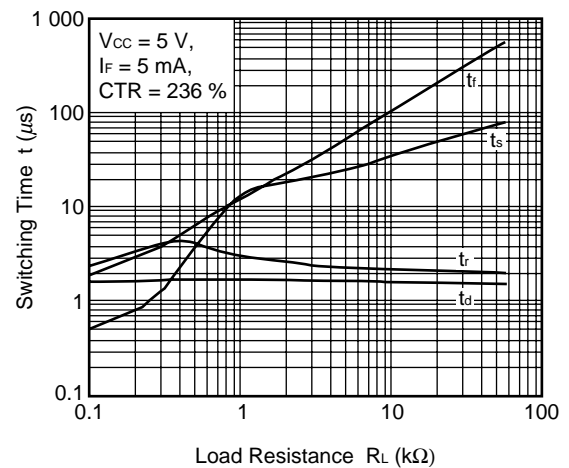
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



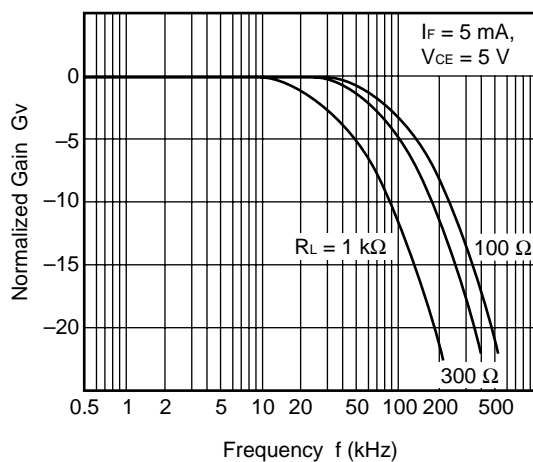
SWITCHING TIME vs. LOAD RESISTANCE



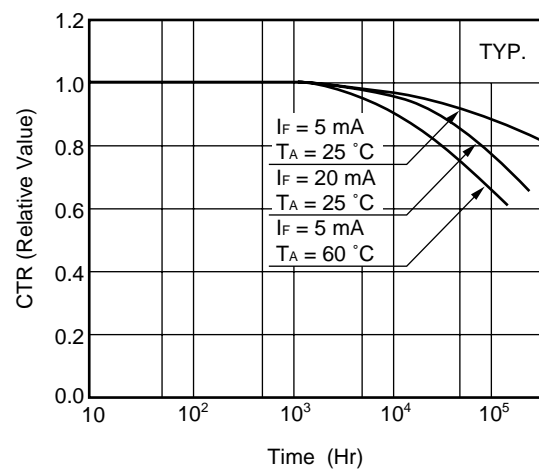
SWITCHING TIME vs. LOAD RESISTANCE



FREQUENCY RESPONSE



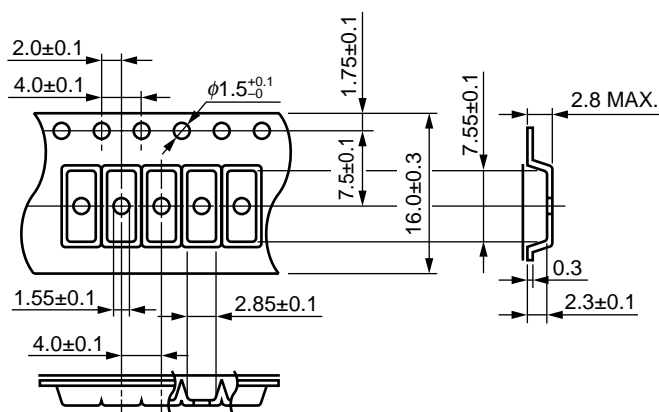
LONG TERM CTR DEGRADATION



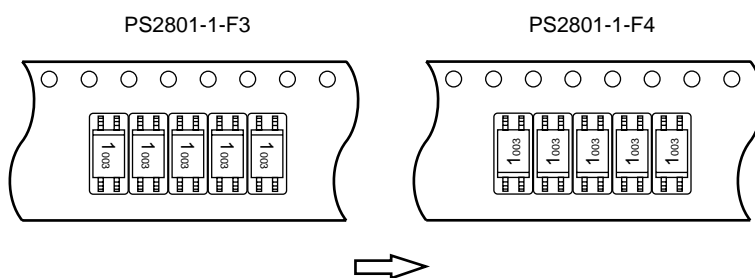
**Remark** The graphs indicate nominal characteristics.

★ TAPING SPECIFICATIONS (UNIT: mm)

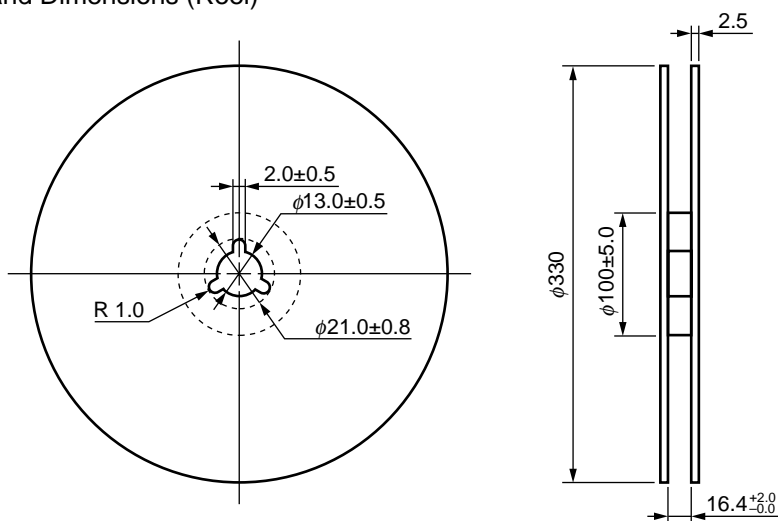
Outline and Dimensions (Tape)



Tape Direction

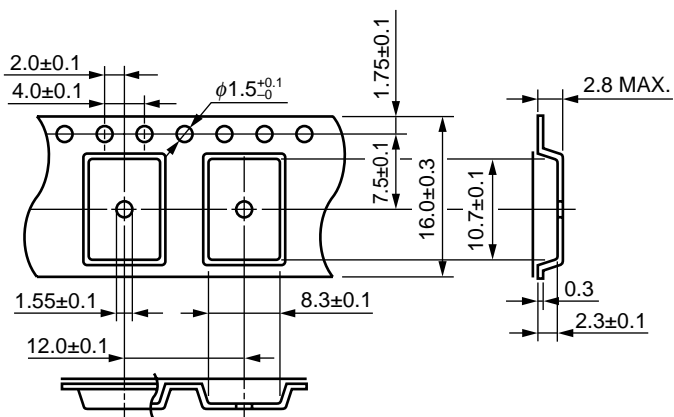


Outline and Dimensions (Reel)

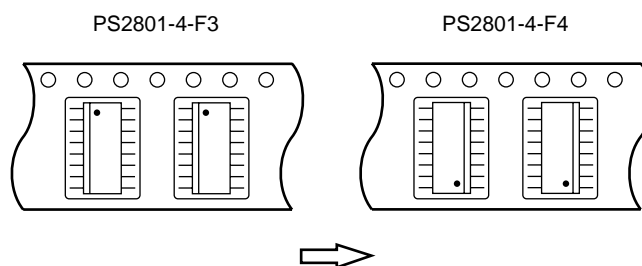


Packing: 3 500 pcs/reel

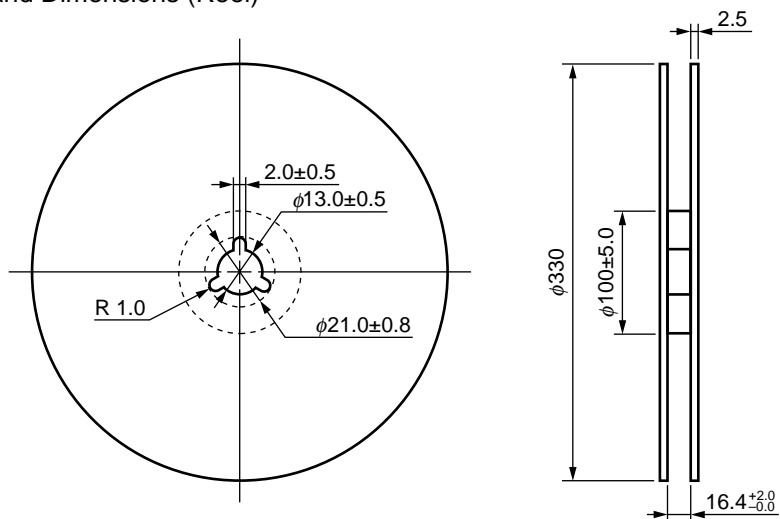
### Outline and Dimensions (Tape)



### Tape Direction



### Outline and Dimensions (Reel)



Packing: 2 500 pcs/reel



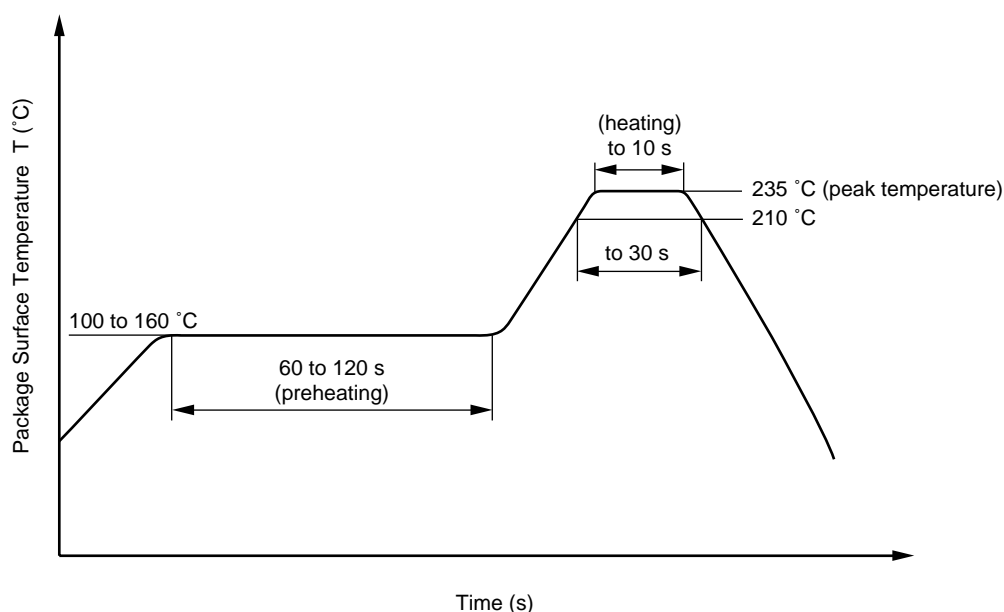
★ NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature 235 °C or below (package surface temperature)
- Time of temperature higher than 210 °C 30 seconds or less
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Dip soldering

- Temperature 260 °C or below (molten solder temperature)
- Time 10 seconds or less
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

(3) Cautions

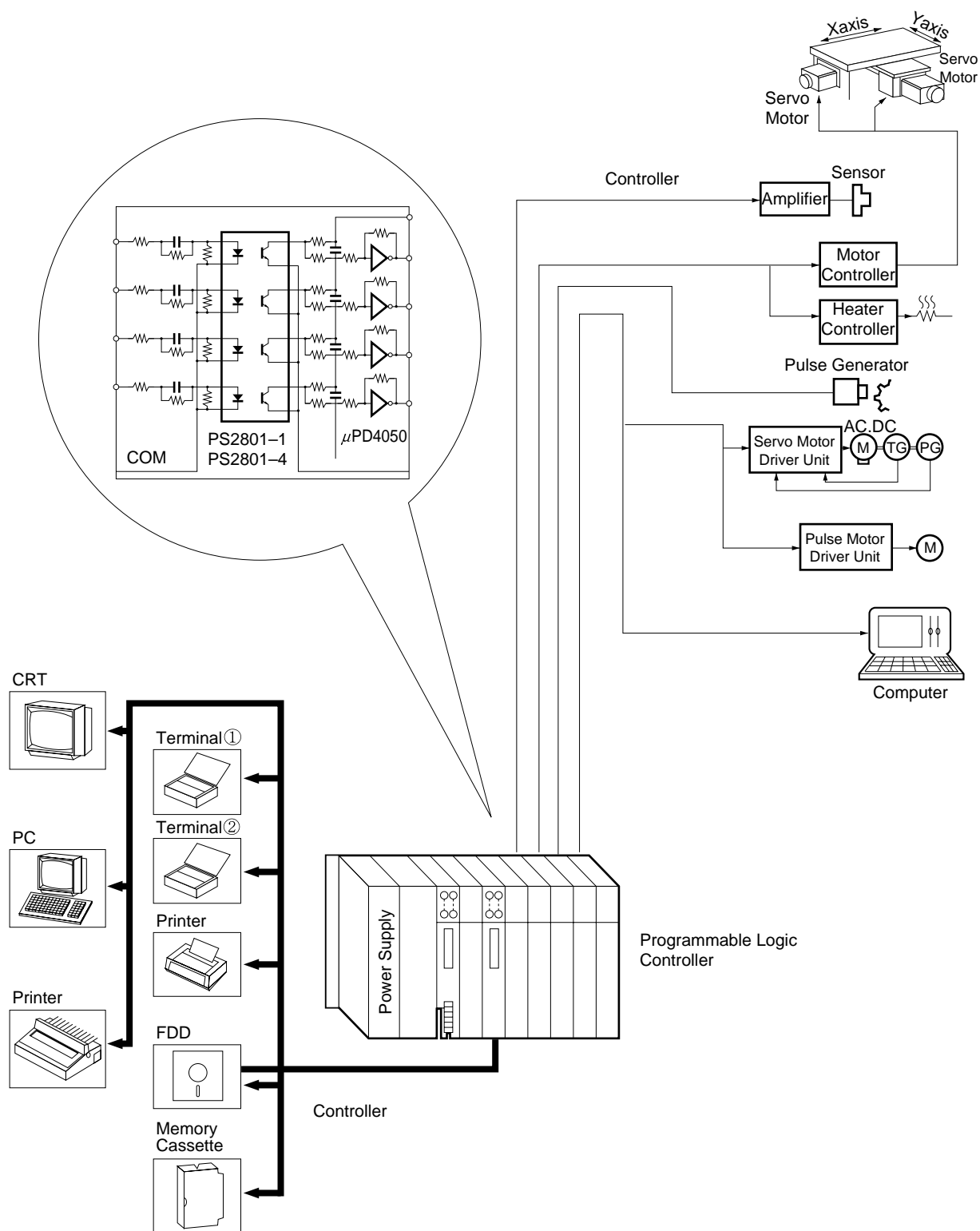
- Fluxes Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between corrector-emitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

# PROGRAMMABLE LOGIC CONTROLLERS EXAMPLE

Purpose: In-out interface



[MEMO]

## CAUTION

**Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.**

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